

12500 TI Boulevard, MS 8640, Dallas, Texas 75243

Notification# 20180926001.0 Datasheet for MSP430FR2633, MSP430FR2632, MSP430FR2533, MSP430FR2532 Information Only

Date: September 28, 2018 **To:** PREMIER FARNELL PCN

Dear Customer:

This is an information-only announcement of a change to the datasheet for a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (PCN ww_admin_team@list.ti.com).

Sincerely,

PCN Team SC Business Services

Information Only Attachments

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
MSP430FR2532IRGET	null
MSP430FR2533IRHBT	null
MSP430FR2632IRGET	null
MSP430FR2632IYQWT	null
MSP430FR2633IRHBT	null
MSP430FR2633IYQWT	null

Technical details of this Product Change follow on the next page(s).

PCN Number:	20180926001	.0	PCN Date:	Septe	ember 28, 2018	
Title: Datasheet for MSP430FR2633, MSP430FR2632, MSP430FR2533, MSP430FR2532						
Customer Contact: P	CN Manager	-	-	De	pt: Quality Services	
Change Type:					· · · · · · · · · · · · · · · · · · ·	
Assembly Site		Design			Wafer Bump Site	
Assembly Process		Data Sheet			Wafer Bump Material	
Assembly Materials		Part numbe	r change		Wafer Bump Process	
Mechanical Specifica	tion	Test Site			Wafer Fab Site	
Packing/Shipping/La	beling	Test Proces	S		Wafer Fab Materials	
					Wafer Fab Process	
		otification	n Details			
Description of Change						
Texas Instruments Incorp		_		y no	tification.	
The product datasheet(s)						
The following change his	tory provides	further detai	lS.			
JA TEXAS		46D430ED363	2 MCD420ED26	32 N	MSP430FR2533, MSP430FR2532	
INSTRUMENTS		W3F430FK203			-NOVEMBER 2015-REVISED AUGUST 2018	
O						
Changes from June 9, 2017 to	August 28, 2018	5			Page	
 Removed "30-cm" from the 	he "Proximity Ser	nsing" item in Se	ction 1.1, Features	s	<u>1</u>	
Updated Section 3.1, Rei	lated Products	mand from OFN	to VOENN in Tabl		Simul Descriptions 47	
					Signal Descriptions <u>17</u> ngs <u>19</u>	
 Added the SNR parameter 	er in Table 5-23,	CapTivate Elect	rical Characteristic	s	<u>41</u>	
Moved "FRAM access tin Table 6.2 Interrupt Source Table 6.2 Interrupt Source Table 6.2 Interrupt Source Table 6.3 Interrupt Source Table 7.3 Interrupt Source T						
Table 6-2, Interrupt Sources, Flags, and Vectors 46 Corrected the offset for P2SEL1 in Table 6-32, Port P1, P2 Registers (Base Address: 0200h) 70						
					<u>86</u>	
The datasheet number will be changing.						
Device Family	in be changing	9.	Change Fro	om:	Change To:	
,				J	change for	
MSP430FR2633, MSP430FR2632, MSP430FR2533,			SLAS!	SLAS942B SLAS9420		
MSP430FR2532						
These changes may be reviewed at the datasheet links provided.						
http://www.ti.com/product/MSP430FR2532						
Reason for Change:						
To accurately reflect device characteristics.						
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):						
No anticipated impact. This is a specification change announcement only. There are no changes to						
the actual device.						
Changes to product identification resulting from this PCN:						
None.						
Product Affected:						
MSP430FR2532IRGER	MSP430FR25	33TRHBR	MSP430FR2632	YIYO	WR MSP430FR2633IRHBR	
MSP430FR2532IRGET	MSP430FR25		MSP430FR2632			
MSP430FR2533IDA	MSP430FR26		MSP430FR2633			
MSP430FR2533IDAR	MSP430FR26	32IRGET	MSP430FR2633	BIDA	R MSP430FR2633IYQWT	

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com